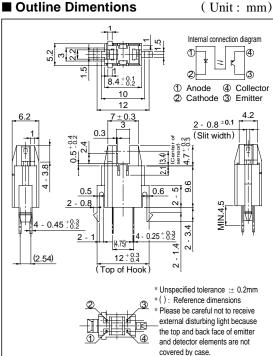
SHARP **GP1S562**

GP1S562

- Features
- 1. Compact package
- 2. With a spacer
- 3. With a hook for temporary installation to PWB
- Applications
- 1. Floppy disk drivers
- 2. VCRs

Compact Photointerrupter with Holders

■ Outline Dimentions



■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

	Parameter	Symbol	Rating	Unit	
Input	Forward current	I_{F}	50	mA	
	*1Peak forward current	I_{FM}	1	A	
	Reverse voltage	V_R	V _R 6		
	Power dissipation	P	75	mW	
	Collecotr-emitter voltage	V_{CEO}	35	V	
0	Emitter-collector voltage	V_{ECO}	6	V	
Output	Collector current	$I_{\rm C}$	20	mA	
	Collector power dissipation	Pc	75	mW	
Operating temperature		Topr	- 25 to + 85	°C	
Storage temperature		T _{stg}	- 40 to + 100	°C	
*2 Soldering temperature		T _{sol}	260	°C	

^{*1} Pulse width<=100 \mu s, Duty ratio: 0.01

^{*2} For 5 seconds

■ Electro-optical Characteristics

 $(Ta = 25^{\circ}C)$

Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		VF	$I_F = 20 \text{mA}$	-	1.25	1.4	V
	Peak forward voltage		V _{FM}	$I_{FM} = 0.5A$	-	3	4	V
	Reverse current		I_R	$V_R = 3V$	-	-	10	μΑ
Output	Collector dark current		I_{CEO}	$V_{CE} = 20V$	-	1	100	nA
Transfer characteristics	Collector current		Ic	$V_{CE} = 5V$, $I_F = 20mA$	1.4	-	8.5	mA
	Collector-emitter saturation voltage		V _{CE(sat)}	$I_F = 40mA, I_C = 1.4mA$	-	-	0.4	V
	Response time	Rise time	$t_{\rm r}$	$V_{CE} = 2V$, $I_{C} = 2mA$	-	3	15	μs
		Fall time	t_{f}	$R_L = 100 \Omega$	-	4	20	μs

Fig. 1 Forward Current vs.

Ambient Temperature

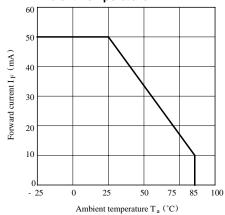


Fig. 3 Peak Forward Current vs. Duty Ratio

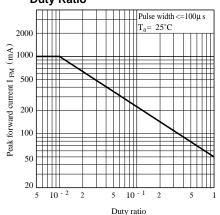


Fig. 2 Collector Power Dissipation vs.
Ambient Temperature

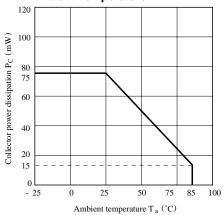


Fig. 4 Forward Current vs. Forward Voltage

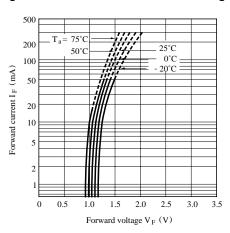


Fig. 5 Collector Current vs. Forward Current

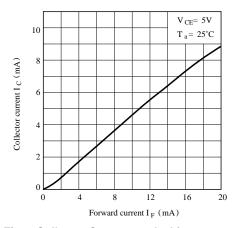


Fig. 7 Collector Current vs. Ambient Temperature

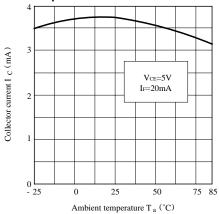


Fig. 9 Response Time vs. Load Resistance

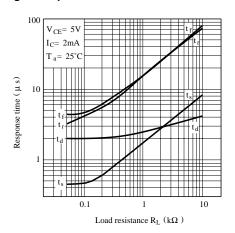


Fig. 6 Collector Current vs. Collector-emitter Voltage

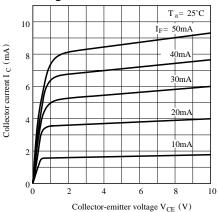
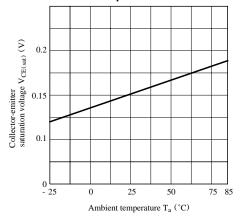


Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature



Test Circuit for Response Time

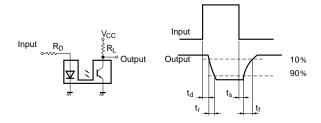
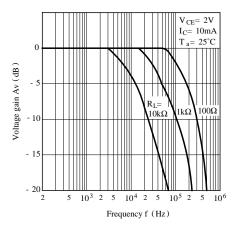
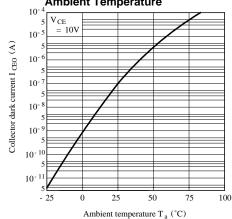


Fig.10 Frequency Response



• Please refer to the chapter "Precautions for Use".

Fig.11 Collector Dark Current vs. Ambient Temperature



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